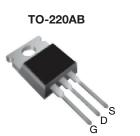
## SiHP33N60EF

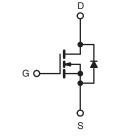
**Vishay Siliconix** 

## **EF Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.098		
Q <sub>g</sub> (Max.) (nC)	155			
Q <sub>gs</sub> (nC)	22			
Q <sub>gd</sub> (nC)	43			
Configuration	Single			

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N-Channel MOSFET

### **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced  $t_{rr},\,Q_{rr},\,and\,I_{RRM}$
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity discharge (HID)
  - Light emitting diodes (LEDs)
- Consumer and computing
- ATX power supplies
- Industrial
  - Welding
- Battery chargersRenewable energy
  - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
  - LLC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free and Halogen-free	SiHP33N60EF-GE3	

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	600				
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
Gate-Source Voltage AC (f > 1 Hz)		30				
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	- I <sub>D</sub>	33	A		
	$V_{GS}$ at 10 V $T_C = 100 \text{ °C}$		21			
Pulsed Drain Current (Typical) <sup>a</sup>	I <sub>DM</sub>	100				
Linear Derating Factor		2.2	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	691	mJ			
Maximum Power Dissipation	PD	278	W			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		70			
Reverse Diode dV/dt <sup>d</sup>		dV/dt	20	V/ns		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s		300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 7$  A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,\, dI/dt = 100$  A/µs, starting  $T_J = 25~^\circ C.$ 

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COMPLIANT HALOGEN

FREE



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.45	0/10	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static		*			-	•	•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Zara Cata Valtaga Drain Current		V <sub>DS</sub> =	= 480 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 16.5 A	-	0.085	0.098	Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> :	= 30 V, I <sub>D</sub> = 16.5 A	-	12	-	S
Dynamic		<u>.</u>					
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	3454	-	
Output Capacitance	C <sub>oss</sub>		V <sub>DS</sub> = 100 V,		154	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	8	-	
Effective Output Capacitance, Energy Related <sup>b</sup>	C <sub>o(er)</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 0 V to 480 V		-	121	-	pF
Effective Output Capacitance, Time Related <sup>c</sup>	C <sub>o(tr)</sub>			-	437	-	
Total Gate Charge	Qg			-	103	155	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 16.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	22	-	
Gate-Drain Charge	Q <sub>gd</sub>		1 [		43	-	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	28	56	-
Rise Time	t <sub>r</sub>	$V_{DD} =$	480 V, I <sub>D</sub> = 16.5 A	-	43	86	
Turn-Off Delay Time	t <sub>d(off)</sub>	R <sub>g</sub> =	$R_{g} = 9.1 \Omega, V_{GS} = 10 V$		161	242	- ns
Fall Time	t <sub>f</sub>	1		-	48	96	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.5	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	33	•
Pulsed Diode Forward Current	I <sub>SM</sub>			-	100	-	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 16.5 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			-	162	324	ns
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, $I_F = I_S = 16.5 \text{ A}$ , dl/dt = 100 A/µs, $V_R = 25 \text{ V}$		-	1.0	2.0	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	13	-	A

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

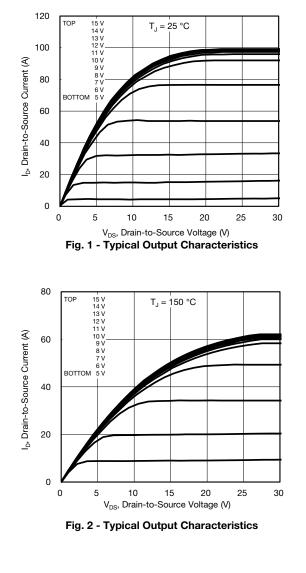
c.  $C_{oss(tr)}$  is a fixed capacitance that gives the charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

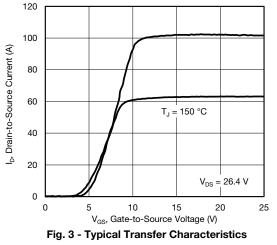


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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





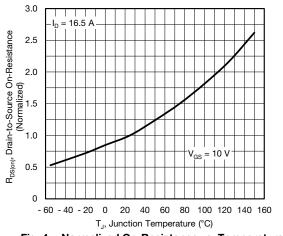


Fig. 4 - Normalized On-Resistance vs. Temperature

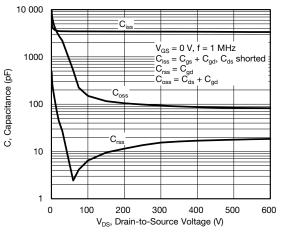
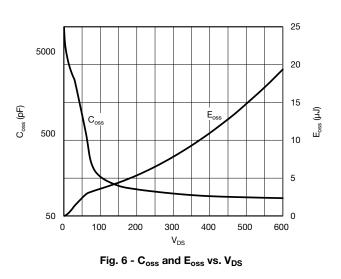


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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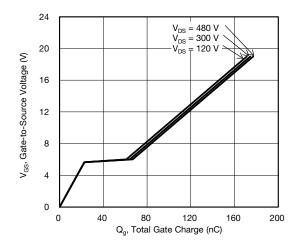


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

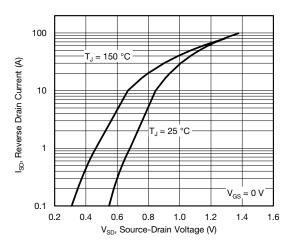


Fig. 8 - Typical Source-Drain Diode Forward Voltage

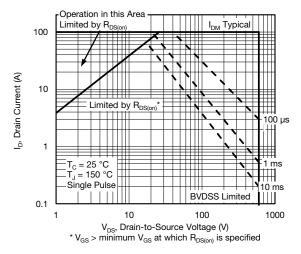


Fig. 9 - Maximum Safe Operating Area

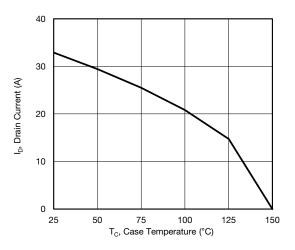


Fig. 10 - Maximum Drain Current vs. Case Temperature

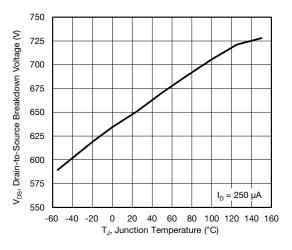
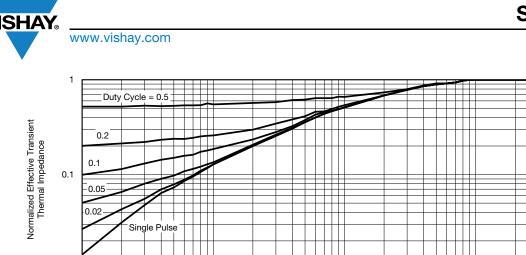


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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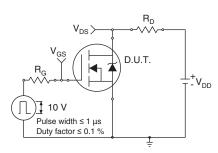
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0.001



0.01



0.01 0.0001

Fig. 13 - Switching Time Test Circuit

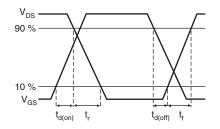


Fig. 14 - Switching Time Waveforms

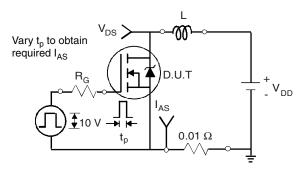


Fig. 15 - Unclamped Inductive Test Circuit

V<sub>DS</sub>  $V_{DD}$ V<sub>DS</sub>  $I_{AS}$ 

0.1

Fig. 16 - Unclamped Inductive Waveforms

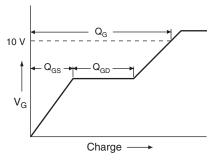


Fig. 17 - Basic Gate Charge Waveform

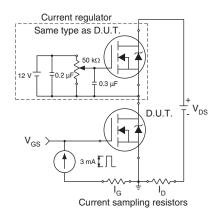
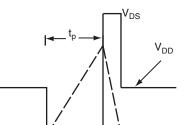


Fig. 18 - Gate Charge Test Circuit

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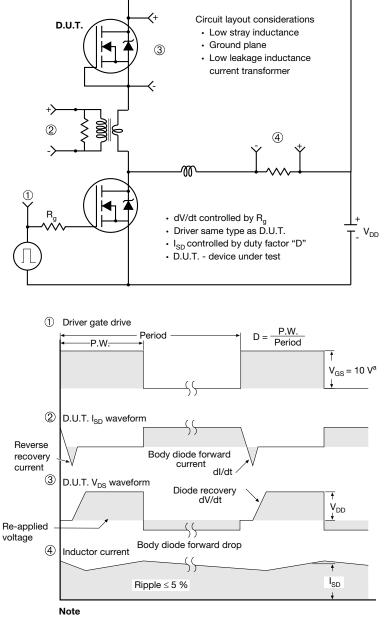
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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